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With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Metal Film Resistors

Precision Type

Normal & Miniature Style [MFP Series]



INTRODUCTION

The MFP Series Metal Film Precision Resistors are manufactured using a vacuum sputtering system to deposit multiple layers of mixed metal alloys and passivative materials onto a carefully treated high grade ceramic substrate. After a helical groove has been cut in the resistive layer, tinned connecting leads of electrolytic copper are welded to the end-caps. The resistors are coated with layers of blue color lacquer. Ultra high precision resistors, ultra high stability, ultra low temperature coefficient.

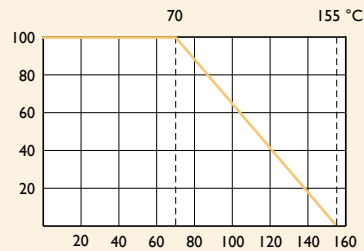
FEATURES

Power Rating	1/6W, 1/4W, 0.4W, 1/2W, 0.6W, 1W, 2W, 3W
Resistance Tolerance	±0.1%, ±0.25%, (±0.02%, ±0.05% on request)
T.C.R.	±15ppm/°C, ±25ppm/°C, (±5ppm/°C, ±10ppm/°C on request)

DERATING CURVE

For resistors operated in ambient temperatures above 70°C, power rating must be derated in accordance with the curve below.

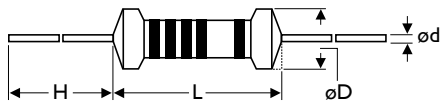
Rated Load (%)



Ambient Temperature (°C)

DIMENSIONS

Unit: mm



STYLE

DIMENSION

Normal	Miniature	L	øD	H	ød
MFP-12	MFP25S	3.4±0.3	1.9±0.2	28±2.0	0.45±0.05
MFP204	-	3.4±0.3	1.9±0.2	28±2.0	0.45±0.05
MFP-25	MFP50S	6.3±0.5	2.4±0.2	28±2.0	0.55±0.05
MFP207	-	6.3±0.5	2.4±0.2	28±2.0	0.55±0.05
MFP-50	MFPIWS	9.0±0.5	3.3±0.3	26±2.0	0.55±0.05
MFPI100	MFP2WS	11.5±1.0	4.5±0.5	35±2.0	0.8±0.05
MFP200	MFP3WS	15.5±1.0	5.0±0.5	33±2.0	0.8±0.05

Note:

ELECTRICAL CHARACTERISTICS

STYLE	MFP-12	MFP25S	MFP204	MFP-25	MFP50S	MFP207	MFP-50	MFPIWS	MFPI00	MFP2WS	MFP200	MFP3WS
Power Rating at 70°C	1/6W	1/4W	0.4W	1/4W	1/2W	0.6W	1/2W	1W		2W		3W
Maximum Working Voltage	150V	200V		250V			350V	400V	500V			
Maximum Overload Voltage	300V	400V		500V	600V		700V	800V	1,000V			
Voltage Proof on Insulation	300V			500V				700V	1,000V			
Resistance Range	10Ω - 1 MΩ for E192 series value											
Operating Temp. Range	-55°C to +155°C											
Temperature Coefficient	±15ppm/°C, ±25ppm/°C											

Note: Special value is available on request

ENVIRONMENTAL CHARACTERISTICS

PERFORMANCE TEST	TEST METHOD		APPRAISE
Short Time Overload	IEC 60115-1 4.13	2.5 times RCWV for 5 Sec.	±0.25%+0.05Ω
Voltage Proof on Insulation	IEC 60115-1 4.7	in V-block for 60 Sec., test voltage by type	By type
Temperature Coefficient	IEC 60115-1 4.8	-55°C to +155°C	By type
Insulation Resistance	IEC 60115-1 4.6	in V-block for 60 Sec.	>10,000MΩ
Solderability	IEC 60115-1 4.17	235±5°C for 3±0.5 Sec.	95% Min. coverage
Solvent Resistance of Marking	IEC 60115-1 4.30	IPA for 5±0.5 Min. with ultrasonic	No deterioration of coatings and markings
Robustness of Terminations	IEC 60115-1 4.16	Direct load for 10 Sec. in the direction of the terminal leads	≥2.5kg (24.5N)
Periodic-pulse Overload	IEC 60115-1 4.39	4 times RCWV 10,000 cycles (1 Sec. on, 25 Sec. off)	±1.0%+0.05Ω
Damp Heat Steady State	IEC 60115-1 4.24	40±2°C, 90-95% RH for 56 days, loaded with 0.1 times RCWV	±1.5%+0.05Ω
Endurance at 70°C	IEC 60115-1 4.25	70±2°C at RCWV for 1,000 Hr. (1.5 Hr. on, 0.5 Hr. off)	±1.5%+0.05Ω
Temperature Cycling	IEC 60115-1 4.19	-55°C ⇌ Room Temp. ⇌ +155°C ⇌ Room Temp. (5 cycles)	±0.75%+0.05Ω
Resistance to Soldering Heat	IEC 60115-1 4.18	260±3°C for 10±1 Sec., immersed to a point 3±0.5mm from the body	±0.25%+0.05Ω

Note: RCWV(Rated Continuous Working Voltage) = $\sqrt{\text{Power Rating} \times \text{Resistance Value}}$ or Max. working voltage listed above, whichever less.

Revision: 201304



EXPLANATIONS OF ORDERING CODE

MFR	-12	F	T	F	52-	100R
Code 1 - 3 Series Name See Index	Code 4 - 6 Power Rating -05 = \varnothing d0.5mm -06 = \varnothing d0.6mm -07 = \varnothing d0.7mm -08 = \varnothing d0.8mm -10 = \varnothing d1.0mm -14 = \varnothing d1.4mm -12 = 1/6W -25 = 1/4W 25S = 1/4WS -50 = 1/2W 50S = 1/2WS 100 = 1W 1WS = 1WS 200 = 2W 2WS = 2WS 204 = 0.4W 207 = 0.6W 300 = 3W 3WS = 3WS 3WM = 3WM 400 = 4W 500 = 5W 5WS = 5WS 5SS = 5WSS 700 = 7W 7WS = 7WS 10A = 10W 20A = 20W 30A = 30W 40A = 40W 50A = 50W 10S = 10WS 15A = 15W 25A = 25W 10B = 100W 25B = 250W	Code 7 Tolerance P = ± 0.02 % A = ± 0.05 % B = ± 0.1 % C = ± 0.25 % D = ± 0.5 % F = ± 1 % G = ± 2 % J = ± 5 % K = ± 10 % - = Base on Spec.	Code 8 Packing Style T = Tape/Box R = Tape/Reel B = Bulk	Code 9 Temperature Coefficient of Resistance - = Base on Spec. A = ± 5 ppm/ $^{\circ}$ C B = ± 10 ppm/ $^{\circ}$ C C = ± 15 ppm/ $^{\circ}$ C S = ± 20 ppm/ $^{\circ}$ C D = ± 25 ppm/ $^{\circ}$ C E = ± 50 ppm/ $^{\circ}$ C F = ± 100 ppm/ $^{\circ}$ C G = ± 200 ppm/ $^{\circ}$ C H = ± 250 ppm/ $^{\circ}$ C I = ± 300 ppm/ $^{\circ}$ C J = ± 350 ppm/ $^{\circ}$ C	Code 10 - 12 Forming Type 26- = 26mm 52- = 52.4mm 73- = 73mm 81- = 81mm 91- = 91mm F = F Type FK = FK Type FKK = FKK Type FFK = F-form Kink M = M-Type Forming MB = M-form W/flat MT = MT Type Forming MR = MR Type AV = AVIsert PN = PANAsert	Code 13 - 17 Resistance Value 0R1 = 0.1 100R = 100 10K = 10,000 10M = 10,000,000

EXCEPTION:

• Cement series:

<Code 8>: Special packing style code

B: Bulk with wirewound or metal oxide sub-assembly for resistance value

W: Bulk with ceramic based wirewound sub-assembly for resistance value

M: Bulk with metal oxide sub-assembly for resistance value

F: Bulk with Fiberglass based wirewound sub-assembly for resistance value

<Code 10-12>: Without forming code

Example: **SQP500JB-10R**

• JPW series:

<Code 13-17>: without resistance value code

Example: **JPW-06-T-52-**